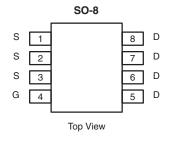




N-Channel 25-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
25	0.004 at V _{GS} = 10 V	28.6	29 nC			
	0.0052 at V _{GS} = 4.5 V	25.6	29 110			



Ordering Information: Si4654DY-T1-E3 (Lead (Pb)-free)

Si4654DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

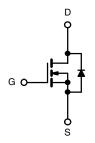
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

ROHS COMPLIANT HALOGEN FREE Available

APPLICATIONS

- Synchronous Buck-Low Side
 Notebook, Game Console
- Synchronous Rectifier-POL



N-Channel MOSFET

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	25	V
Gate-Source Voltage		V_{GS}	± 16	v
	T _C = 25 °C		28.6	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	1 . [23	
Continuous Diain Current (1) = 130 °C)	T _A = 25 °C	l _D	18.6 ^{b, c}	
	T _A = 70 °C	T	14.9 ^{b, c}	A
Pulsed Drain Current		I _{DM}	70	_ ^
Continuous Source-Drain Diode Current	T _C = 25 °C		5.1	
Continuous Source-Diam Diode Current	T _A = 25 °C	Is	2.2 ^{b, c}	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	30	
Avalanche Energy		E _{AS}	45	mJ
	T _C = 25 °C		5.9	
Maximum Power Dissipation	T _C = 70 °C	P _D	3.8	w
Maximum Fower Dissipation	T _A = 25 °C	1 '	2.5 ^{b, c}	
	T _A = 70 °C	1 -	1.6 ^{b, c}	
Operating Junction and Storage Temperatur	e Range	T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	37	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	21	O/ V V		

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static			•		•	I.	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		26		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	ι _D = 230 μΑ		- 5.6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.0		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			± 100	nA	
Zana Cata Valta na Duain Comunant	1	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}$	1		1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
	Б	V _{GS} = 10 V, I _D = 15 A		0.0032	0.004	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.004	0.0052	Ω	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 15 A		100		S	
Dynamic ^b							
Input Capacitance	C _{iss}			3770		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		560			
Reverse Transfer Capacitance	C _{rss}			255			
Total Gate Charge	0	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		63	100	nC	
Total Gate Charge	Q_g			29	45		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		8.5			
Gate-Drain Charge	Q_gd			7.2			
Gate Resistance	R_g	f = 1 MHz		0.9	1.8	Ω	
Turn-On Delay Time	t _{d(on)}			30	50		
Rise Time	t _r	V_{DD} = 15 V, R_L = 3 Ω		10	20	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		50	90		
Fall Time	t _f			10	20	no	
Turn-On Delay Time	t _{d(on)}			12	24	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 3 Ω		8	16		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		38	70		
Fall Time	t _f			8	16		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			5.1	Α	
Pulse Diode Forward Current ^a	I _{SM}				70	^	
Body Diode Voltage	V _{SD}	I _S = 3 A		0.73	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			32	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 5 A, dl/dt = 100 A/μs, T _J = 25 °C		26	55	nC	
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, I_J = 25 \text{ °C}$		16		no	
Reverse Recovery Rise Time	t _b			16		ns	

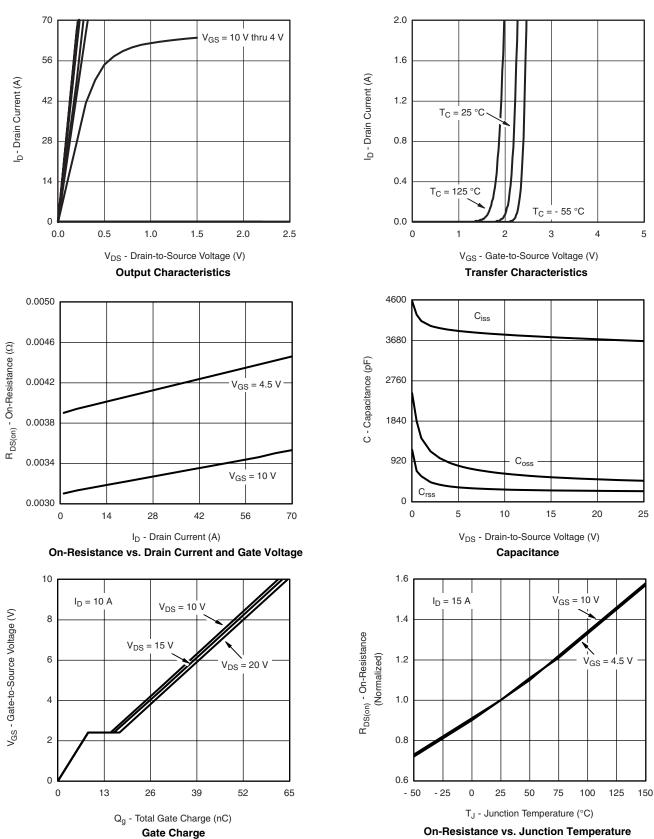
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





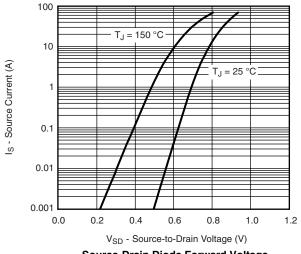
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

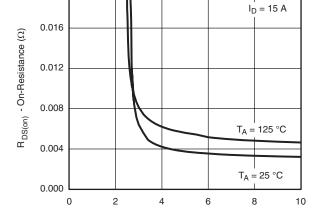


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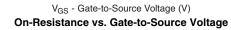
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

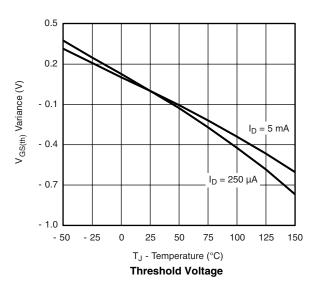


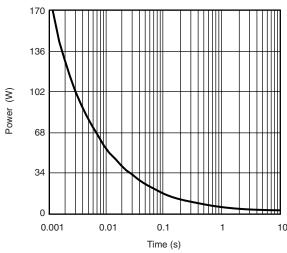


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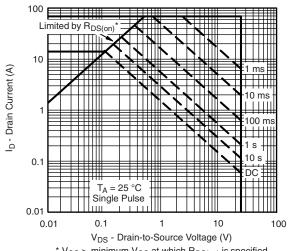
Source-Drain Diode Forward Voltage







Single Pulse Power, Junction-to-Ambient

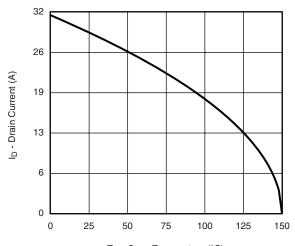


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

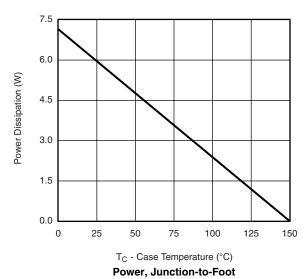


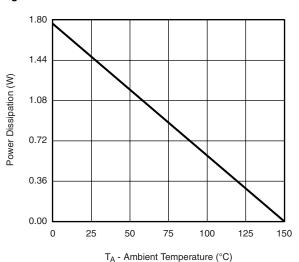
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T_C - Case Temperature (°C)

Current Derating*





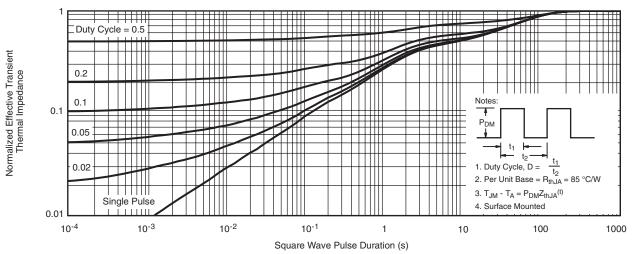
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

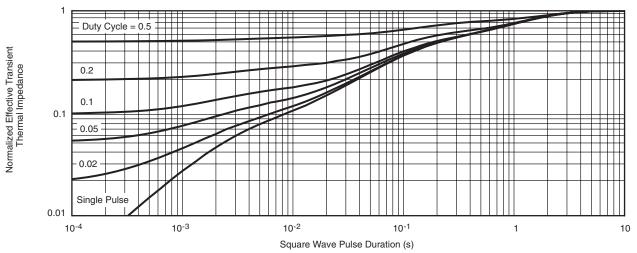
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
FCN: C-06527-Bev 11-Sen-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06 www.vishay.com



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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